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SPE® THERMOSET DIV. ANNOUNCES CALL FOR PAPERS, SPONSORS & EXHIBITORS FOR THERMOSET TOPCON MAY 12 – 13, 2020 IN MADISON, WISCONSIN
“THERMOSETS – MOLDING AMERICA FOR OVER 100 YEARS”

The SPE Thermoset Div. is announcing its annual call for papers, exhibitors, and sponsors for their annual event to be held on May 12 – 13, 2020 at the Monona Terrace and Convention Center in Madison, Wisconsin. “THERMOSETS – MOLDING AMERICA FOR OVER 100 YEARS,” is the theme for the 2020 event celebrating over a century of thermoset innovations and advancements. “Thermoset technologies continue to evolve and drive new composite applications in various industries. Composites have been molding America since 1907 when Dr. Leo Baekeland invented Bakelite, the world’s first thermoset compound,” said Richard Faulk, Product Manager, Materials Division Mar-Bal, Inc. and SPE Thermoset Div. Chair. “The SPE Thermoset TopCon 2020 will return to Madison, where we had once partnered with the University of Wisconsin, Madison for many years. In fact, the Thermoset Molding Conference started in 1954 and we are very excited to be back to celebrate the history, product advancements, and the future of thermoset technology,” continued Faulk.

The SPE Thermoset TopCon 2020 will feature technical presentations and exhibits highlighting advances in materials, processes, and equipment for thermoset technologies in electrical, automotive, off-highway, appliance, aerospace, building and construction, oil and gas, and other industries. The day and a half conference includes a networking breakfast, lunch and cocktail reception on May 12, and breakfast and a keynote and/or additional sessions in the morning on May 13. Optional social events, including a golf outing at University Ridge Golf Course and a cruise of the Madison shoreline via private yacht with deluxe appetizers and beverages are offered on May 11, the day before the conference begins.
**Paper abstracts** are due January 30, 2020 but requested ASAP as limited time slots are available. Send abstracts to teri@intuitgroup.com. **Speakers are invited to attend the event free of charge. OEMs are offered free registration as well.** A variety of exhibit and non-exhibit sponsorship packages offering opportunities for company exposure are available. Companies interested in showcasing their products and/or services, and individuals interested in registering to attend the event should go to [https://spethermosets.org/topcon/](https://spethermosets.org/topcon/) for more information or contact Teri Chouinard at teri@intuitgroup.com.

**Conference Venue:**

Inspired by Wisconsin native Frank Lloyd Wright’s design, at the peak of his creative powers in 1938, the Monona Terrace Community and Convention Center is one of the country’s premier conference and convention facilities. On the shores of Lake Monona, it is an architecturally striking structure that connects the state capital, the cityscape, and the community. The conference exhibits, meals and cocktail reception will be in the Community Terrace with pristine views of Lake Monona offering a relaxing and enjoyable experience. The presentations will be in the Lecture Hall offering comfortable theatre style seating, staging and professional audio-visual support. Special rates are provided for conference attendees at the Hilton Madison Monona Terrace which is connected via skywalk to the conference venue. See [https://www.mononaterrace.com](https://www.mononaterrace.com) and [https://www3.hilton.com/](https://www3.hilton.com/) for more info.

**Sponsors:**

SPE Thermoset TopCon 2020 sponsors to date include: Mar-Bal, Inc.; WesTool Corporation; Plenco (Plastics Engineering Company); Glenwood Tool & Mold, Inc.; Omya AG; Chromaflo Technologies; Huber Engineered Materials; IDI Composites; Fox Valley Molding, Inc.; and ICT Molding Solutions.

The mission of SPE is to promote scientific and engineering knowledge relating to composites worldwide and to educate industry, academia, and the public about the technological advances. SPE’s Thermoset Division is active in educating, promoting, recognizing, and communicating technical accomplishments in thermoset technology in multiple industries. Topic areas include applications, materials, processing, equipment, tooling, design, and development.

For more information see [https://spethermosets.org/topcon/](https://spethermosets.org/topcon/) For more information on the Society of Plastics Engineers, see [www.4spe.org](http://www.4spe.org).

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